

The 19th International Meeting on Lithium Batteries

IMLB2018

June 17-22

kyoto international conference center
Kyoto, Japan

The 19th International Meeting on Lithium Batteries

June 17 (Sun) to 22 (Fri), 2018
Kyoto International Conference Center (KICC), Kyoto, Japan

Exhibit and Sponsorship Opportunity

Application Deadline: March 15, 2018

Do not miss your big chance to showcase your products and services on batteries!
For more information, please contact: sponsor@imlb2018.org

IMLB, LLC



The Committee of
**Battery
Technology**
The Electrochem. Soc., Japan



The Electrochemical Society of Japan

IMLB2018 is sponsored by IMLB LLC, The Committee of Battery Technology, Japan and The Electrochemical Society of Japan.

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IMLB2018 is the premier international conference on the state-of-art science and technology of lithium-ion batteries and beyond, as well as current and future applications in transportation and energy storage. The meeting is expected to draw more than 1,000 experts, researchers, and company representatives involved in the lithium battery field.

IMLB 2018 will provide an exciting forum to discuss recent progress in advanced lithium batteries for energy storage and conversion. The meeting will focus on both basic and applied research findings that have led to improved Li battery materials, and to the understanding of the fundamental processes that determine and control electrochemical performance. A major theme of the meeting will address recent advances not only in lithium-ion technologies, but also beyond lithium-ion technologies.

Organizing Committee

Chairperson

Minoru Inaba,* Doshisha University, Japan

Co-Chairpersons

Takeshi Abe, Kyoto University, Japan
Yoshiharu Uchimoto, Kyoto University, Japan

International Scientific Committee

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Doron Aurbach,* Bar-Ilan University, Israel
Peter Bruce,* Oxford University, UK
Yi Cui,* Stanford University, USA
Jeff R. Dahn,* Dalhousie University, Canada
Clare Grey,* Cambridge University, UK
Dominique Guyomard,* IMN, France
Bing-Joe Hwang, National Taiwan University of Science and Technology, Taiwan
Juergen Janek,* Giessen University, Germany
Kiyoshi Kanamura, Tokyo Metropolitan University, Japan
Robert Kostecki, Berkeley National Laboratory, USA
Sang-Yong Lee, Ulsan National Institute of Science and Technology, Korea
Hong Li,* Chinese Academy of Science, China
Wenjuan Liu Mattiss,* Microvast, China
Christian Masquelier, Universite de Picardie Jules Verne, France
Shirley Meng, University of California at San Diego, USA
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Petr Novak,* Paul Scherrer Institut, Switzerland

Zempachi Ogumi,* Kyoto University, Japan
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Shigetoh Okada, Kyushu University, Japan
Tetsuya Osaka,* Waseda University, Japan
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Yang Shao-Horn,* Massachusetts Institute of Technology, USA
Jean-Marie Tarascon,* College de France, France
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Josh Thomas,* Uppsala University, Sweden
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*Board Member of IMLB LLC

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Sponsorship Opportunities

General Meeting Sponsorship	Platinum 3,000,000 JPY (Limit 1)	Gold 1,000,000 JPY	Silver 500,000 JPY	Bronze 250,000 JPY
Your company listing & logo (linked to your site) on the meeting website	Yes	Yes	Yes	Yes
Your logo in the meeting program	Yes	Yes	Yes	Yes
Your logo on the congress bag	Yes	No	No	No
Free Ad (in color) in the IMLB meeting program	Full page (Back Cover)	Full page	Full page	1/2 page
Complimentary meeting registrations (including banquet)	5	3	2	1
Short speech (2 min) at banquet	Yes	Yes	Yes	Yes
Complimentary Exhibit Booth	2	1	1	0

Other levels of sponsorship can be tailored to fit your company's needs.

Technical Exhibit Opportunities

Booth & Display Features

All standard booths include:

- One skirted table (1,800 x 900 mm) with two side chairs
- One back panel (2,100 mm height) with your company name at the top
- Electricity: 100 V, 500 W per booth
- Your company listing & logo on the web and in the meeting program
- Two complimentary registrations for all social events (reception, coffee, lunch, and banquet).

Pricing

250,000 JPY per one booth

Application Information

Booth Reservations are first-come, first-served

Deadlines

Application Deadline: March 15, 2018

Full Balance Due: May 16, 2018

Meeting Program Advertising

Share your message with meeting attendees by advertising in the IMLB program book (A4 size). All ads are full color and must be received by March 15, 2018. Please note that gold, silver, and bronze sponsors receive complimentary ads in the meeting program as noted above table. Technical Exhibit pricing does not include the advertising in the meeting abstract book

Options & Pricing

Inside Front or Back Cover	250,000 JPY
Full Page	200,000 JPY
Half Page	100,000 JPY
Quarter Page	50,000 JPY

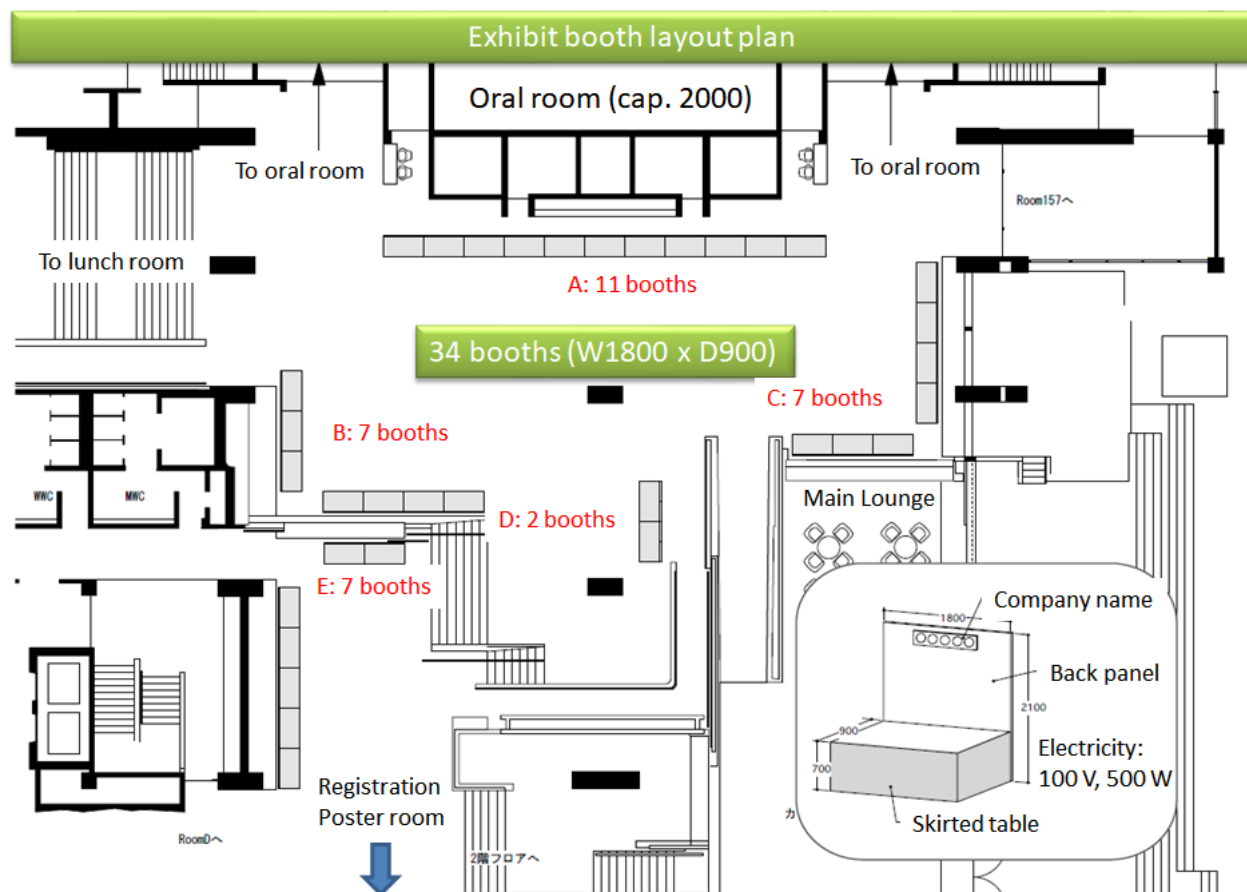
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Meeting and Exhibit Schedule

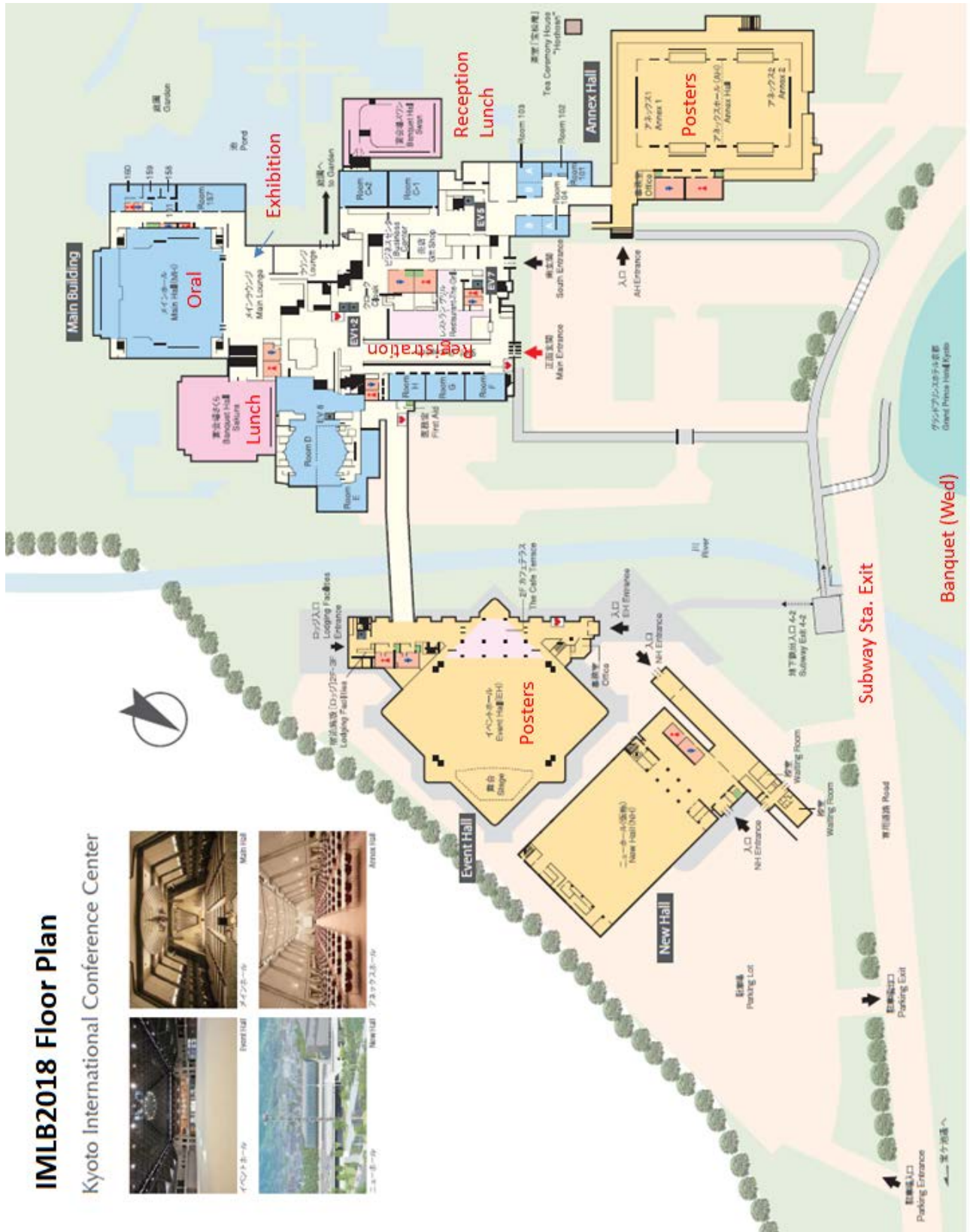
Date	Meeting	Exhibition
June 17, Sunday	16:00-19:00 Registration 18:00-20:00 Reception	
June 18, Monday	9:00-12:00 Morning session 12:00-13:30 Lunch 13:30-18:00 Afternoon session 18:30-20:30 Poster session	9:00- 12:00 Move in 10:30-18:00 Exhibition
June 19, Tuesday	9:00-12:00 Morning session 12:00-13:30 Lunch 13:30-18:00 Afternoon session 18:30-20:30 Poster session	9:00-18:00 Exhibition
June 20, Wednesday	9:00-12:00 Morning session 12:00-13:30 Lunch 13:30-18:00 Afternoon session 19:00-20:00 Banquet	9:00-18:00 Exhibition
June 21, Thursday	9:00-12:00 Morning session 12:00-13:30 Lunch 13:30-18:00 Afternoon session 18:30-20:30 Poster session	9:00-18:00 Exhibition
June 22, Friday	9:00-12:00 Morning session	9:00-12:00 Tear Down



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Exhibit and Sponsorship Application

Please complete pages 6-7 and return to sponsor@imlb2018.org along with a 50 word organization description by March 15, 2018.

Organization Information

Date:

Organization:

Contact Name:

Title:

Address:

City:

State:

Postal Code:

Country:

Telephone:

Fax:

E-mail Address:

Website:

Please note that the contact information noted on this application will be displayed on the IMLB website and in printed materials. **Please not on Page 7 if you prefer to display information different from that listed above.**

Payment Information

Sponsorship and exhibit costs are payable to IMLB in Japanese Yen by a credit card or bank/wire transfer. The full balance is due by **May16, 2018**.

Credit Card

(I hereby authorize JTB Western Japan Corp (3-1-8, Minami Kyuhoji-cho, Chuo-ku, Osaka, Japan, 541-0058) charge my credit card for the "grand total".)

Card Type

Visa

Master Card

American Express

Cardholder's Name

Card Number

Expiration Date: MM/YYYY

Signature

Date

Request Bank/Wire Transfer Information

Please send an invoice for the balance of my payment.

